OPA356
OPA2356

SBOS212A – NOVEMBER, 2001

200MHz, CMOS OPERATIONAL AMPLIFIER

FEATURES

- **UNITY-GAIN BANDWIDTH: 450MHz**
- **WIDE BANDWIDTH: 200MHz GBW**
- **HIGH SLEW RATE: 360V/μs**
- **LOW NOISE: 5.8nV/√Hz**
- **EXCELLENT VIDEO PERFORMANCE: DIFF GAIN: 0.02%, DIFF PHASE: 0.05° 0.1dB GAIN FLATNESS: 75MHz**
- **INPUT RANGE INCLUDES GROUND**
- **RAIL-TO-RAIL OUTPUT (within 100mV)**
- **LOW INPUT BIAS CURRENT: 3pA**
- **THERMAL SHUTDOWN**
- **SINGLE-SUPPLY OPERATING RANGE: 2.5V to 5.5V**
- ***Micro*SIZE PACKAGES**

APPLICATIONS

- **VIDEO PROCESSING**
- **ULTRASOUND**
- **OPTICAL NETWORKING, TUNABLE LASERS**
- **PHOTODIODE TRANSIMPEDANCE AMPS**
- **ACTIVE FILTERS**
- **HIGH-SPEED INTEGRATORS**
- **ANALOG-TO-DIGITAL (A/D) CONVERTER INPUT BUFFERS**
- **DIGITAL-TO-ANALOG (D/A) CONVERTER OUTPUT AMPLIFIERS**
- **BARCODE SCANNERS**
- **COMMUNICATIONS**

DESCRIPTION

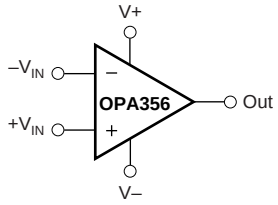
The OPAx356 series high-speed, voltage-feedback CMOS operational amplifiers are designed for video and other applications requiring wide bandwidth. The OPAx356 is unity gain stable and can drive large output currents. Differential gain is 0.02% and differential phase is 0.05°. Quiescent current is only 8.3mA per channel.

OPAx356 is optimized for operation on single or dual supplies as low as 2.5V (±1.25V) and up to 5.5V (±2.75V). Common-mode input range for the OPAx356 extends 100mV below ground and up to 1.5V from V+. The output swing is within 100mV of the rails, supporting wide dynamic range.

The OPAx356 series is available in single (SOT23-5 and SO-8), and dual (MSOP-8 and SO-8) versions. Multichannel versions feature completely independent circuitry for lowest crosstalk and freedom from interaction. All are specified over the extended –40°C to +125°C range.

OPAx356 RELATED PRODUCTS

FEATURES	PRODUCT
200MHz, Rail-to-Rail Output, CMOS, Shutdown	OPAx355
38MHz, Rail-to-Rail Input/Output, CMOS	OPAx350
75MHz, Rail-to-Rail Output	OPAx631
150MHz, Rail-to-Rail Output	OPAx634
Differential Input/Output, 3.3V Supply	THS412x



ABSOLUTE MAXIMUM RATINGS(1)

Supply Voltage, V+ to V–	7.5V
Signal Input Terminals, Voltage(2)	(V–) – 0.5V to (V+) + 0.5V
Current(2)	10mA
Output Short-Circuit(3)	Continuous
Operating Temperature	–55°C to +150°C
Storage Temperature	–65°C to +150°C
Junction Temperature	+160°C
Lead Temperature (soldering, 10s)	+300°C

NOTE: (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied. (2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.5V beyond the supply rails should be current limited to 10mA or less. (3) Short-circuit to ground one amplifier per package.

ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

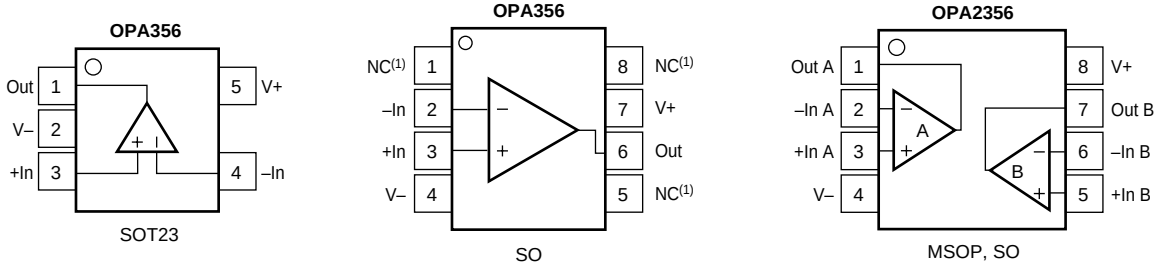
PACKAGE/ORDERING INFORMATION

PRODUCT	PACKAGE-LEAD	PACKAGE DESIGNATOR(1)	SPECIFIED TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER(2)	TRANSPORT MEDIA, QUANTITY
OPA356AIDBV	SOT23-5	DBV	–40°C to +125°C	OAAI	OPA356AIDBVT	Tape and Reel, 250
"	"	"	"	"	OPA356AIDBVR	Tape and Reel, 3000
OPA356AID	SO-8	D	–40°C to +125°C	OPA356A	OPA356AID	Rails, 100
"	"	"	"	"	OPA356AIDR	Tape and Reel, 2500
OPA2356AIDGK	MSOP-8	DGK	–40°C to +125°C	AYI	OPA2356AIDGKT	Tape and Reel, 250
"	"	"	"	"	OPA2356AIDGKR	Tape and Reel, 2500
OPA2356AID	SO-8	D	–40°C to +125°C	OPA2356A	OPA2356AID	Rails, 100
"	"	"	"	"	OPA2356AIDR	Tape and Reel, 2500

NOTES: (1) For the most current specifications and package information, refer to our web site at www.ti.com. (2) Models labeled with "T" indicate smaller quantity tape and reel, "R" indicates large quantity tape and reel and "D" indicates rails of specified quantity.

PIN CONFIGURATIONS

Top View



NOTE: (1) NC means no internal connection.

ELECTRICAL CHARACTERISTICS: V_S = +2.7V to +5.5V Single Supply

Boldface limits apply over the specified temperature range, T_A = –40°C to +125°C.

At T_A = +25°C, R_F = 604Ω, R_L = 150Ω, Connected to V_S/2, unless otherwise noted.

PARAMETER		CONDITION	OPA356AIDBV, AID, OPA2356AIDGK, AID MIN	TYP	MAX	UNITS
OFFSET VOLTAGE						
Input Offset Voltage	V_{OS}	V_S = +5V		±2	±9	mV
		Specified Temperature Range			**±15**	**mV**
vs Temperature	**dV_{OS}/dT**	**Specified Temperature Range**		**±7**		**µV/°C**
vs Power Supply	PSRR	V_S = +2.7V to +5.5V, V_{CM} = V_S/2 – 0.15V		±80	±350	µV/V
INPUT BIAS CURRENT						
Input Bias Current	I_B			3	±50	pA
Input Offset Current	I_{OS}			±1	±50	pA
NOISE						
Input Noise Voltage Density	e_n	f = 1MHz		5.8		$nV/\sqrt{Hz}$
Current Noise Density	i_n	f = 1MHz		50		$fA/\sqrt{Hz}$
INPUT VOLTAGE RANGE						
Common-Mode Voltage Range	V_{CM}		(V–) – 0.1		(V+) – 1.5	V
Common-Mode Rejection Ratio	CMRR	V_S = +5.5V, –0.1V < V_{CM} < +4.0V	66	80		dB
		Specified Temperature Range	**66**			**dB**
INPUT IMPEDANCE						
Differential				10^{13} || 1.5		Ω || pF
Common-Mode				10^{13} || 1.5		Ω || pF
OPEN-LOOP GAIN		V_S = +5V, 0.3V < V_O < 4.7V	84	92		dB
	OPA356	**V_S = +5V, 0.3V < V_O < 4.7V**	**80**			**dB**
	OPA2356	**V_S = +5V, 0.4V < V_O < 4.6V**	**80**			**dB**
FREQUENCY RESPONSE						
Small-Signal Bandwidth	f_{-3dB}	G = +1, V_O = 100mVp-p, R_F = 0Ω		450		MHz
	f_{-3dB}	G = +2, V_O = 100mVp-p, R_L = 50Ω		100		MHz
	f_{-3dB}	G = +2, V_O = 100mVp-p, R_L = 150Ω		170		MHz
	f_{-3dB}	G = +2, V_O = 100mVp-p, R_L = 1kΩ		200		MHz
Gain-Bandwidth Product	GBW	G = +10, R_L = 1kΩ		200		MHz
Bandwidth for 0.1dB Gain Flatness	$f_{0.1dB}$	G = +2, V_O = 100mVp-p, R_F = 560Ω		75		MHz
Slew Rate	SR	V_S = +5V, G = +2, 4V Output Step		300/–360		V/µs
Rise-and-Fall Time		G = +2, V_O = 200mVp-p, 10% to 90%		2.4		ns
		G = +2, V_O = 2Vp-p, 10% to 90%		8		ns
Settling Time, 0.1%		V_S = +5V, G = +2, 2V Output Step		30		ns
0.01%		V_S = +5V, G = +2, 2V Output Step		120		ns
Overload Recovery Time		V_{IN} • Gain = V_S		8		ns
Harmonic Distortion						
2nd Harmonic		G = +2, f = 1MHz, V_O = 2Vp-p, R_L = 200Ω		–81		dBc
3rd Harmonic		G = +2, f = 1MHz, V_O = 2Vp-p, R_L = 200Ω		–93		dBc
Differential Gain Error		NTSC, R_L = 150Ω		0.02		%
Differential Phase Error		NTSC, R_L = 150Ω		0.05		degrees
Channel-to-Channel Crosstalk	OPA2356	f = 5MHz		–90		dB
OUTPUT						
Voltage Output Swing from Rail		V_S = +5V, R_L = 150Ω, A_{OL} > 84dB		0.2	0.3	V
Voltage Output Swing from Rail		V_S = +5V, R_L = 1kΩ		0.1		V
Voltage Output Swing from Rail		I_O = ±100mA		0.8	1	V
Ouput Current, Continuous[1]	I_O		±60			mA
Maximum Output Current, Peak[1]	I_O	V_S = +5V	±100			mA
Maximum Output Current, Peak[1]	I_O	V_S = +3V		±80		mA
Short Circuit Current				+250/–200		mA
Closed-Loop Output Impedance		f < 100kHz		0.02		Ω
POWER SUPPLY						
Specified Voltage Range	V_S		2.7		5.5	V
Operating Voltage Range				2.5 to 5.5		V
Quiescent Current (per amplifier)	I_Q	V_S = +5V, I_O = 0		8.3	11	mA
		Specified Temperature Range			**14**	**mA**

ELECTRICAL CHARACTERISTICS: V_S = +2.7V to +5.5V Single Supply (Cont.)

Boldface limits apply over the specified temperature range, **T_A = –40°C to +125°C.**

At T_A = +25°C, R_F = 604Ω, R_L = 150Ω, Connected to V_S/2, unless otherwise noted.

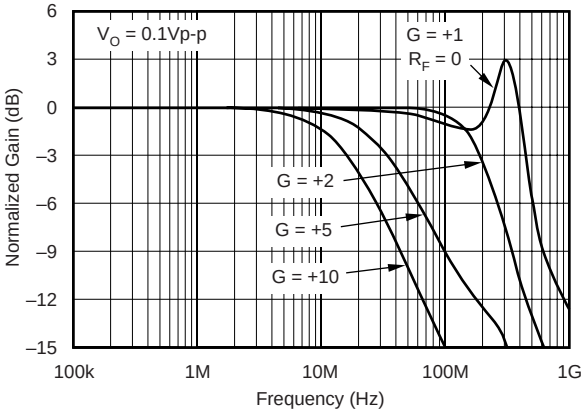
PARAMETER	CONDITION	OPA356AIDBV, AID, OPA2356AIDGK, AID			UNITS
		MIN	TYP	MAX	
THERMAL SHUTDOWN					
Junction Temperature					
Shutdown			160		°C
Reset from Shutdown			140		°C
TEMPERATURE RANGE					
Specified Range		–40		125	°C
Operating Range		–55		150	°C
Storage Range		–65		150	°C
Thermal Resistance θ_{JA}					°C/W
SOT23-5, MSOP-8			150		°C/W
SO-8			125		°C/W

NOTES: (1) See typical characteristic “Output Voltage Swing vs Output Current”.

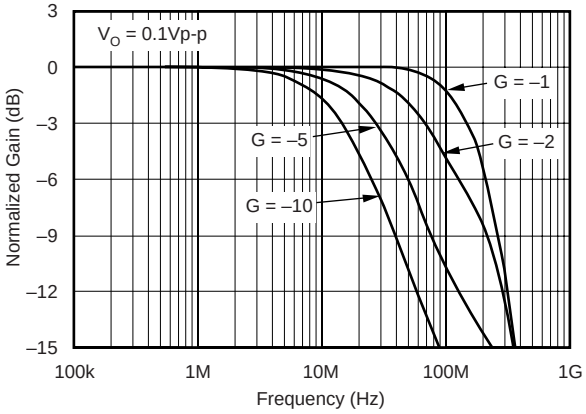
TYPICAL CHARACTERISTICS

At T_A = +25°C and V_S = 5V, G = +2, R_F = 604Ω, R_L = 150Ω connected to V_S/2, unless otherwise noted.

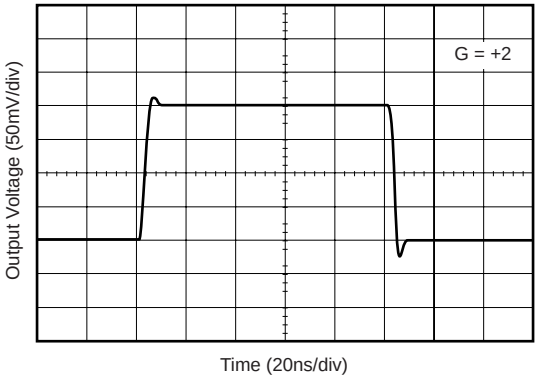
NON-INVERTING SMALL-SIGNAL FREQUENCY RESPONSE



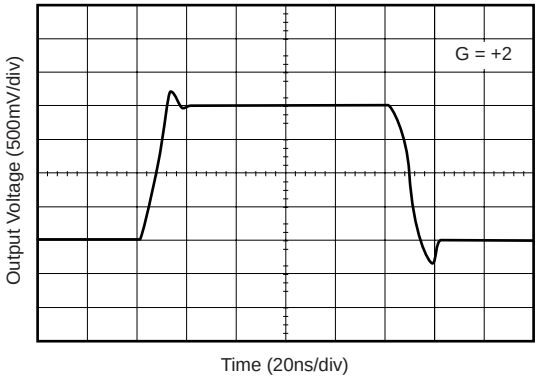
INVERTING SMALL-SIGNAL FREQUENCY RESPONSE



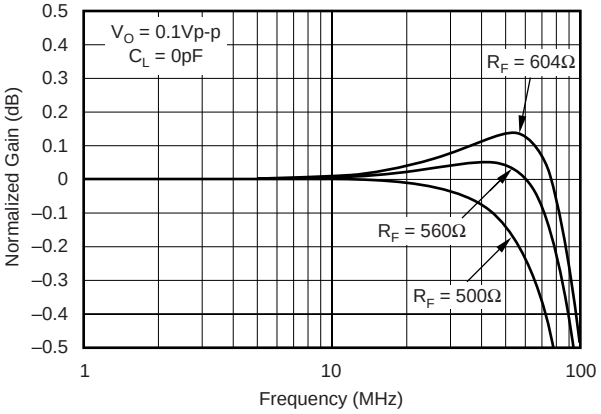
NON-INVERTING SMALL-SIGNAL STEP RESPONSE



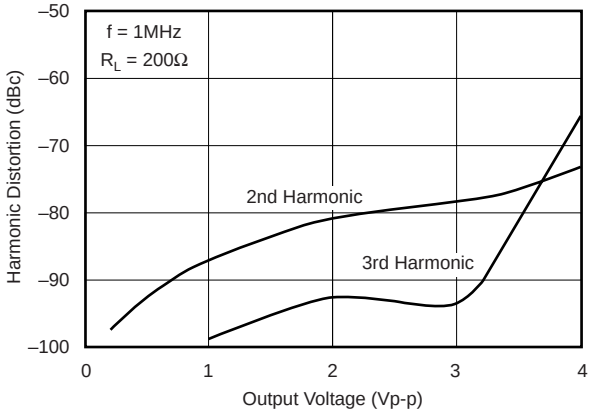
NON-INVERTING LARGE-SIGNAL STEP RESPONSE



0.1dB GAIN FLATNESS FOR VARIOUS R_F



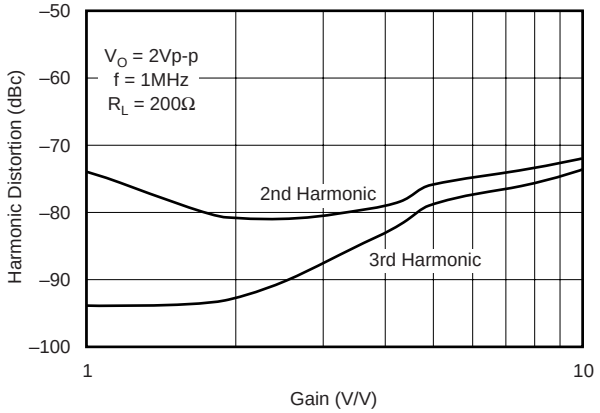
HARMONIC DISTORTION vs OUTPUT VOLTAGE



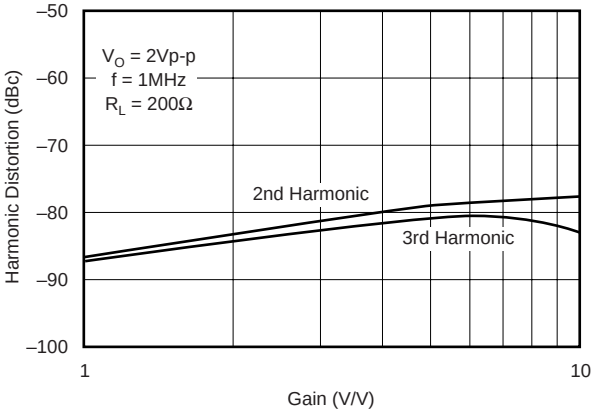
TYPICAL CHARACTERISTICS (Cont.)

At T_A = +25°C and V_S = 5V, G = +2, R_F = 604Ω, R_L = 150Ω connected to V_S/2, unless otherwise noted.

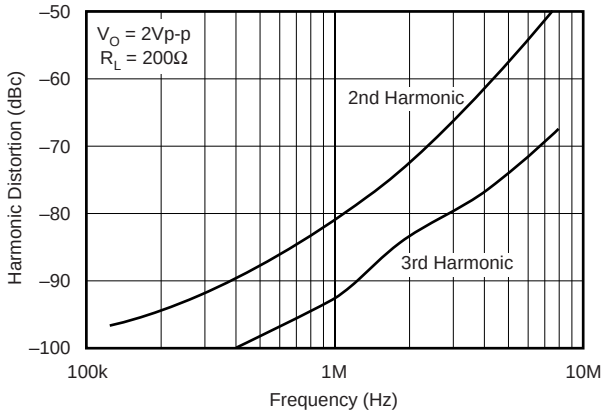
HARMONIC DISTORTION vs NON-INVERTING GAIN



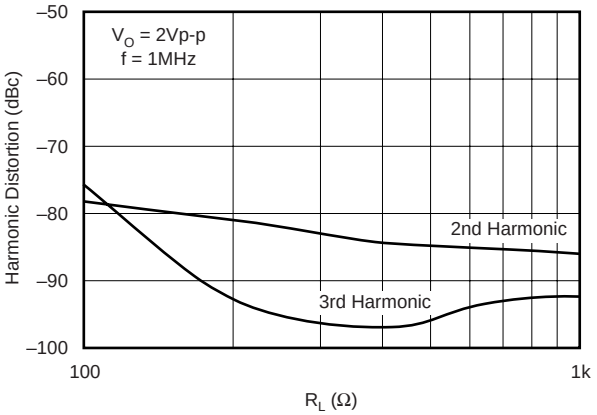
HARMONIC DISTORTION vs INVERTING GAIN



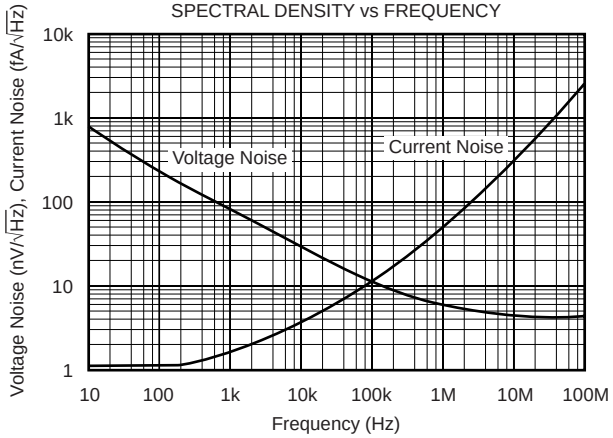
HARMONIC DISTORTION vs FREQUENCY



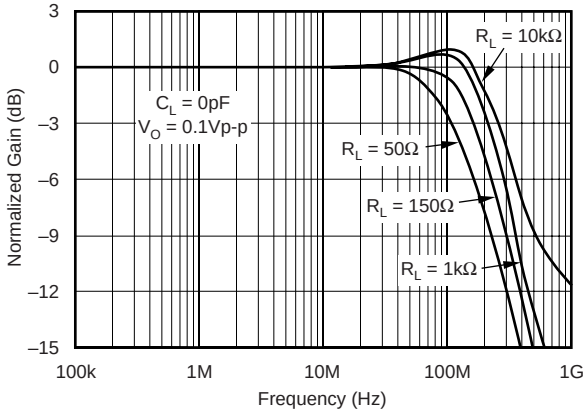
HARMONIC DISTORTION vs LOAD RESISTANCE



INPUT VOLTAGE AND CURRENT NOISE SPECTRAL DENSITY vs FREQUENCY



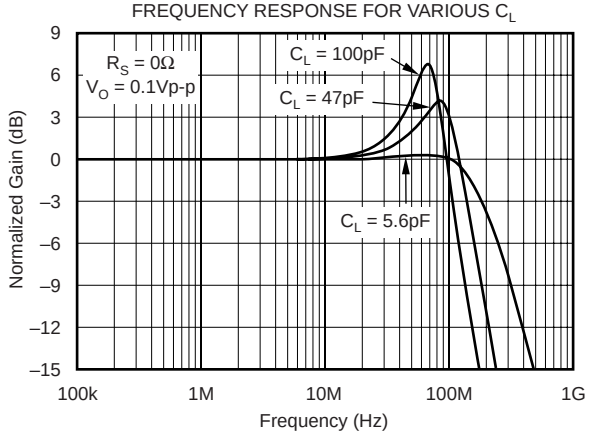
FREQUENCY RESPONSE FOR VARIOUS R_L



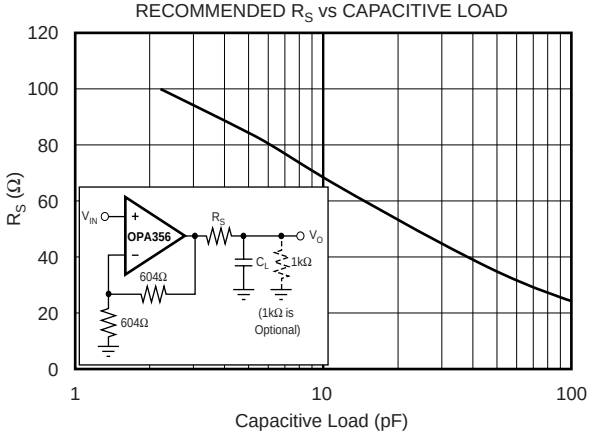
TYPICAL CHARACTERISTICS (Cont.)

At T_A = +25°C and V_S = 5V, G = +2, R_F = 604Ω, R_L = 150Ω connected to V_S/2, unless otherwise noted.

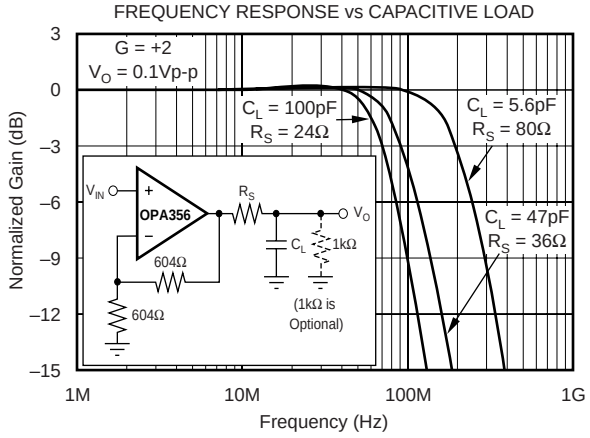
FREQUENCY RESPONSE FOR VARIOUS C_L



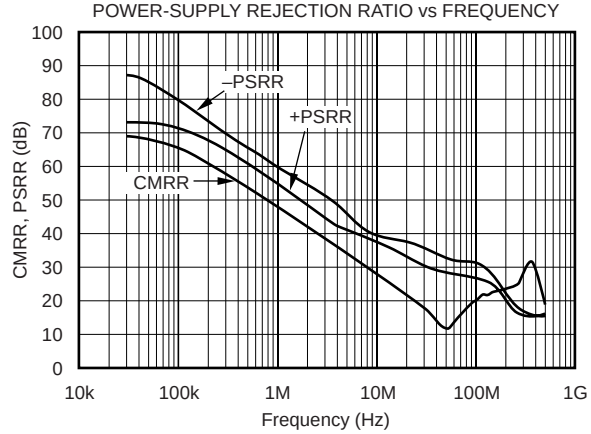
RECOMMENDED R_S vs CAPACITIVE LOAD



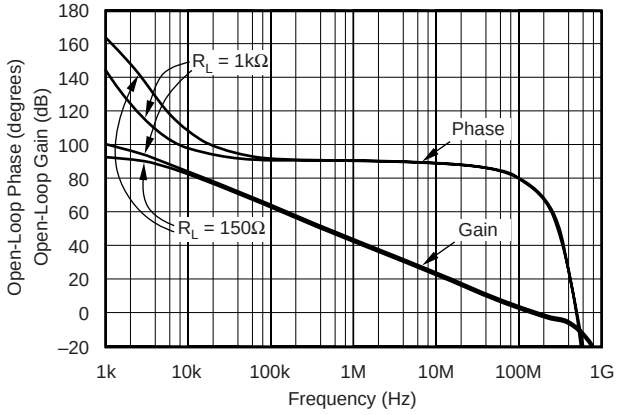
FREQUENCY RESPONSE vs CAPACITIVE LOAD



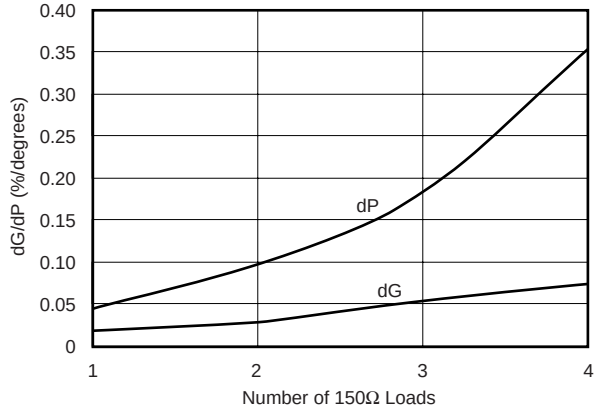
COMMON-MODE REJECTION RATIO AND POWER-SUPPLY REJECTION RATIO vs FREQUENCY



OPEN-LOOP GAIN AND PHASE



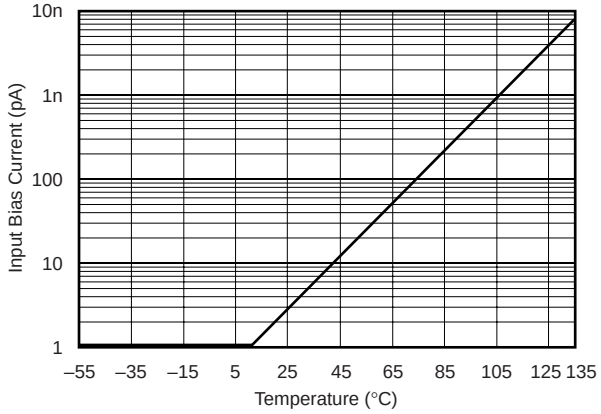
COMPOSITE VIDEO DIFFERENTIAL GAIN AND PHASE



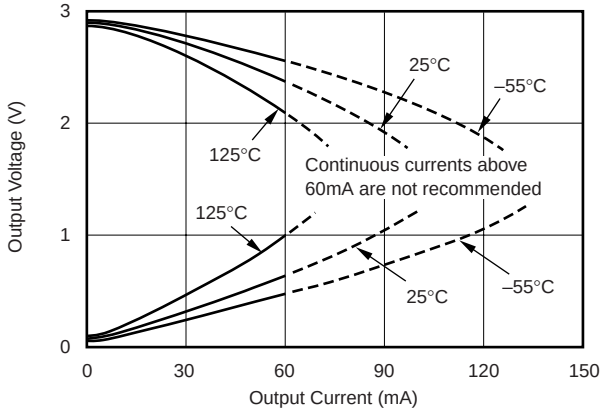
TYPICAL CHARACTERISTICS (Cont.)

At T_A = +25°C and V_S = 5V, G = +2, R_F = 604Ω, R_L = 150Ω connected to V_S/2, unless otherwise noted.

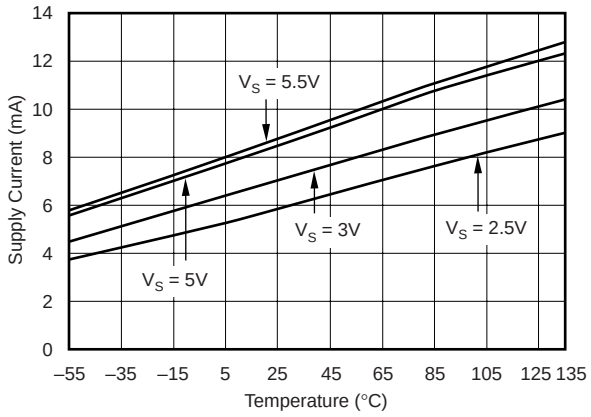
INPUT BIAS CURRENT vs TEMPERATURE



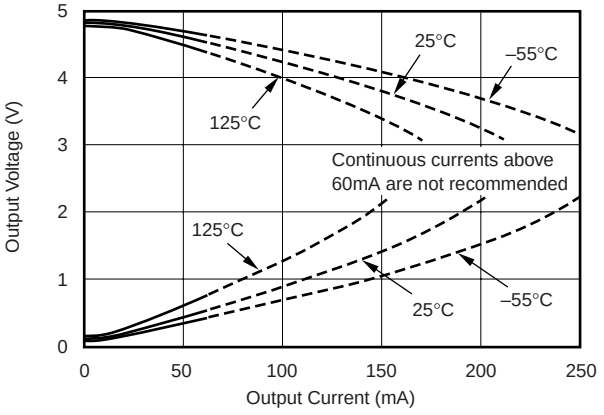
OUTPUT VOLTAGE SWING vs OUTPUT CURRENT FOR V_S = 3V



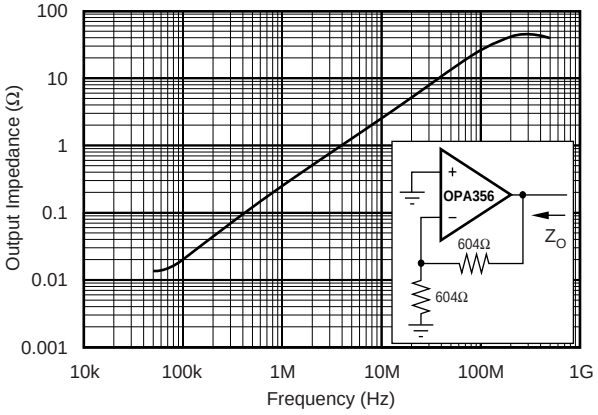
SUPPLY CURRENT vs TEMPERATURE



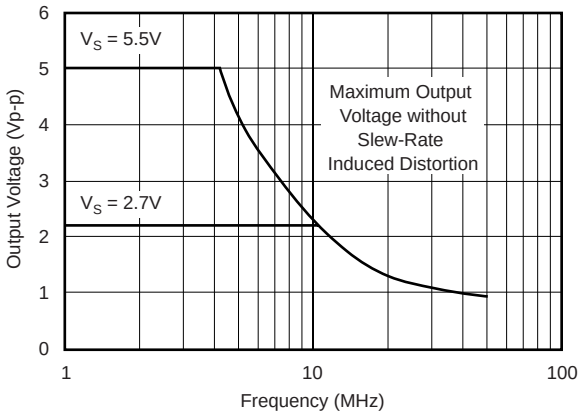
OUTPUT VOLTAGE SWING vs OUTPUT CURRENT FOR V_S = 5V



CLOSED-LOOP OUTPUT IMPEDANCE vs FREQUENCY



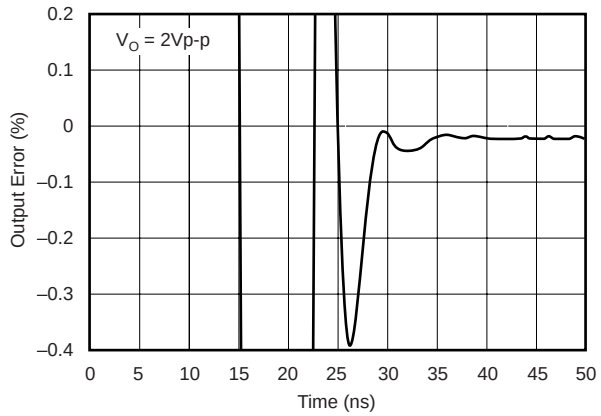
MAXIMUM OUTPUT VOLTAGE vs FREQUENCY



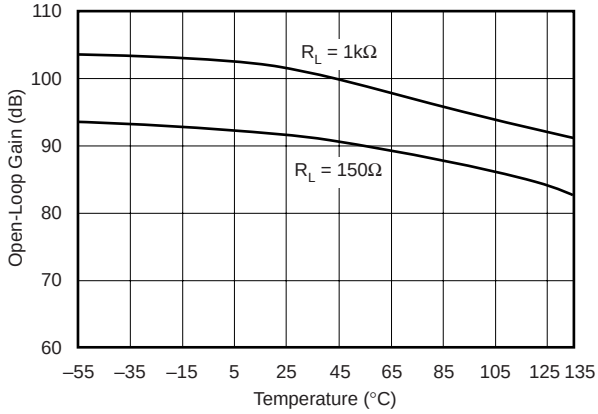
TYPICAL CHARACTERISTICS (Cont.)

At T_A = +25°C and V_S = 5V, G = +2, R_F = 604Ω, R_L = 150Ω connected to V_S/2, unless otherwise noted.

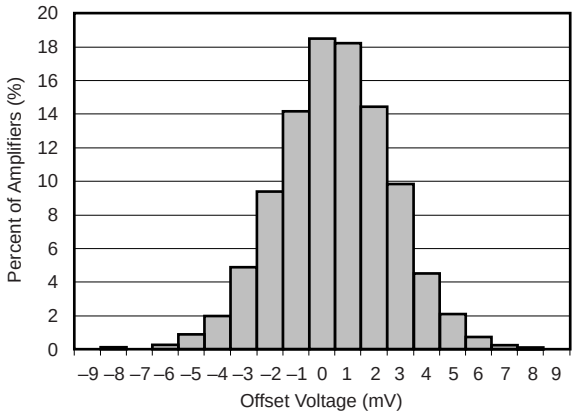
OUTPUT SETTLING TIME TO 0.1%



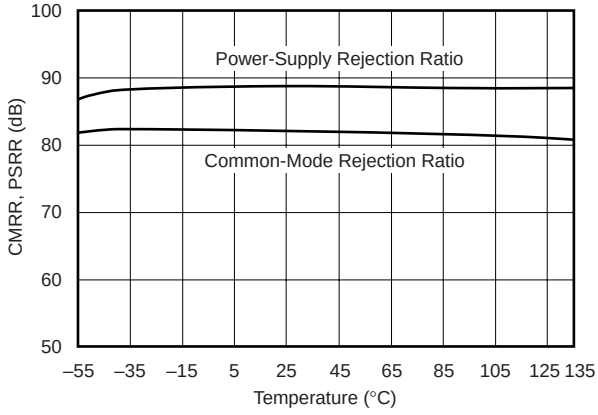
OPEN-LOOP GAIN vs TEMPERATURE



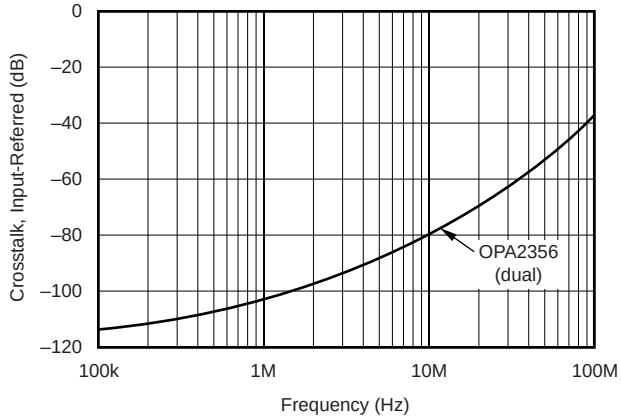
OFFSET VOLTAGE PRODUCTION DISTRIBUTION



COMMON-MODE REJECTION RATIO AND POWER-SUPPLY REJECTION RATIO vs TEMPERATURE



CHANNEL-TO-CHANNEL CROSSTALK



APPLICATIONS INFORMATION

The OPAx356 series is a CMOS, high-speed, voltage feedback, operational amplifier designed for video and other general-purpose applications. It is available as a single or dual op amp.

The amplifier features a 200MHz gain bandwidth and 360V/µs slew rate, but it is unity-gain stable and can be operated as a +1V/V voltage follower.

Its input common-mode voltage range includes ground, allowing the OPAx356 to be used in virtually any single-supply application up to a supply voltage of +5.5V.

PCB LAYOUT

Good high-frequency PC board layout techniques should be employed for the OPAx356. Generous use of ground planes, short direct signal traces, and a suitable bypass capacitor located at the V+ pin will assure clean, stable operation. Large areas of copper also provide a means of dissipating heat that is generated within the amplifier in normal operation.

Sockets are definitely not recommended for use with any high-speed amplifier.

A 10µF ceramic bypass capacitor is the minimum recommended value; adding a 1µF or larger tantalum capacitor in parallel can be beneficial when driving a low-resistance load. Providing adequate bypass capacitance is essential to achieving very low harmonic and intermodulation distortion.

OPERATING VOLTAGE

The OPAx356 is specified over a power-supply range of +2.7V to +5.5V (±1.35 to ±2.75V). However, the supply voltage may range from +2.5V to +5.5V (±1.25V to ±2.75V). Supply voltages higher than 7.5V (absolute maximum) can permanently damage the amplifier.

Parameters that vary significantly over supply voltage or temperature are shown in the “Typical Characteristics” section of this data sheet.

OUTPUT DRIVE

The OPAx356 output stage is capable of driving a standard back-terminated 75Ω video cable. By back-terminating a transmission line, it does not exhibit a capacitive load to its driver. A properly back-terminated 75Ω cable does not appear as capacitance; it presents only a 150Ω resistive load to the OPAx356 output.

The output stage can supply high short-circuit current (typically over 200mA). Therefore, an on-chip thermal shutdown circuit is provided to protect the OPAx356 from dangerously high junction temperatures. At 160°C, the protection circuit will shut down the amplifier. Normal operation will resume when the junction temperature cools to below 140°C.

NOTE: It is not recommended to run a continuous DC current in excess of ±60mA. Refer to the graph of “Output Voltage Swing vs Output Current”, shown in the “Typical Characteristics” section of this data sheet.

INPUT AND ESD PROTECTION

All OPAx356 pins are static protected with internal ESD protection diodes tied to the supplies, as shown in Figure 1.

These diodes will provide overdrive protection if the current is externally limited to 10mA by the source or by a resistor.

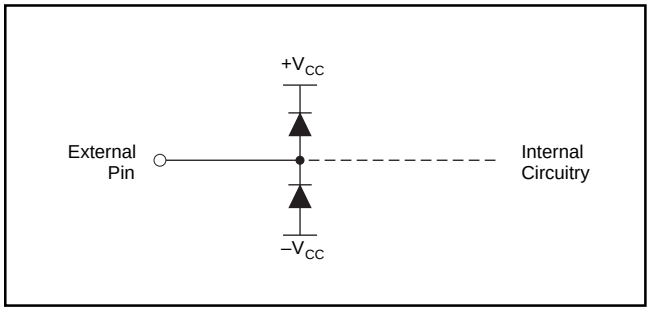
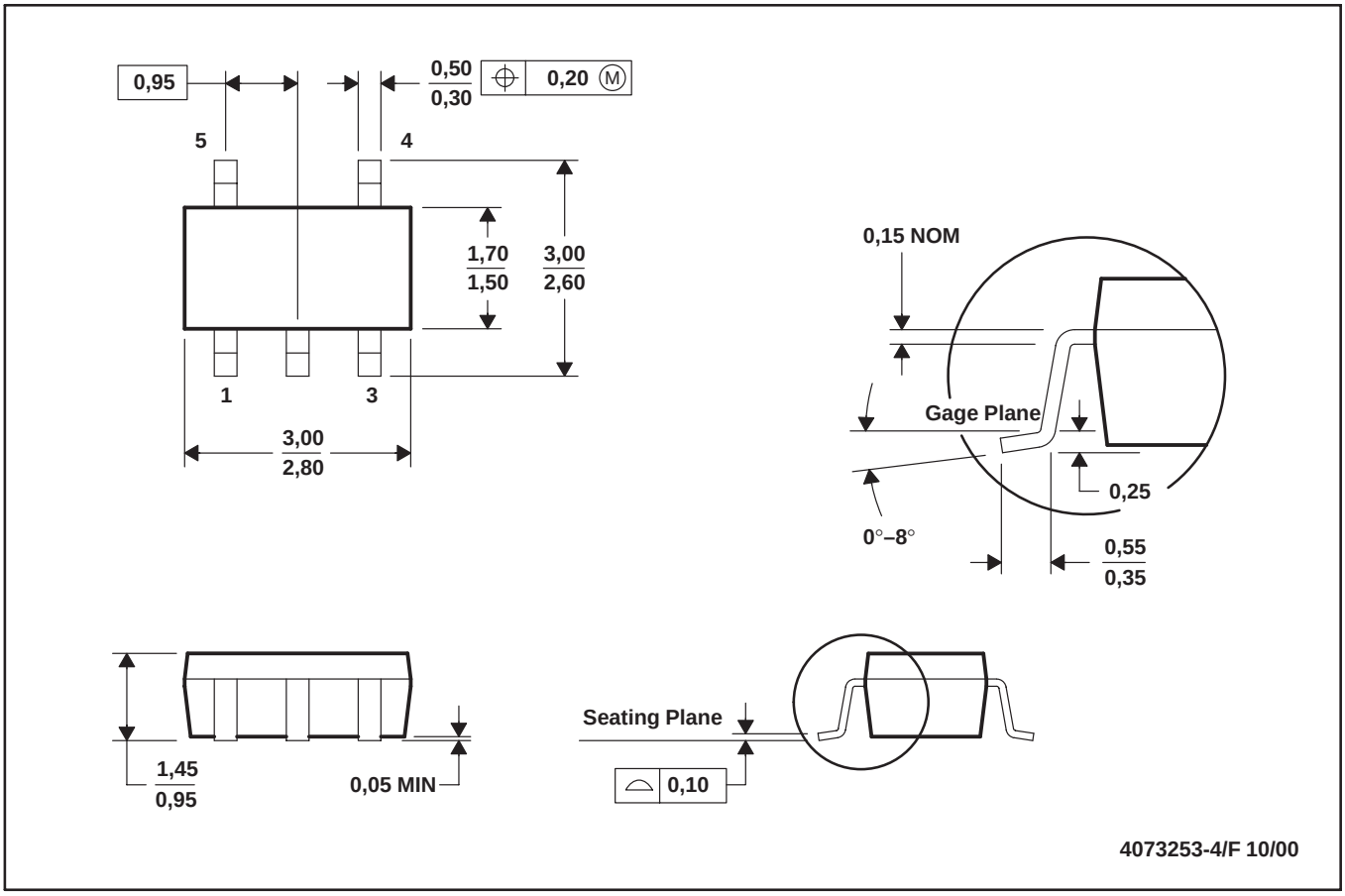


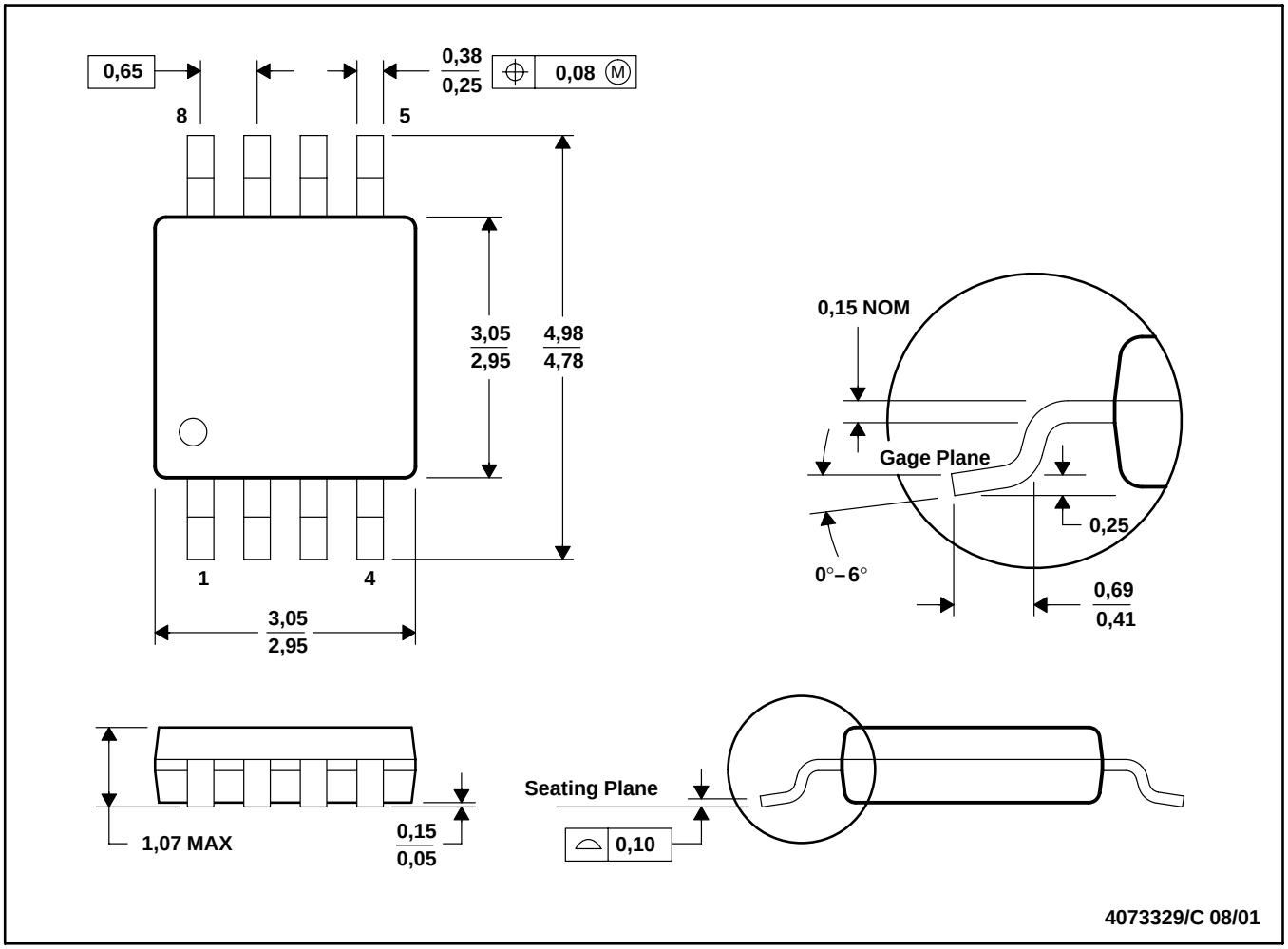
FIGURE 1. Internal ESD Protection.

DBV (R-PDSO-G5) **PLASTIC SMALL-OUTLINE**



NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion.
D. Falls within JEDEC MO-178

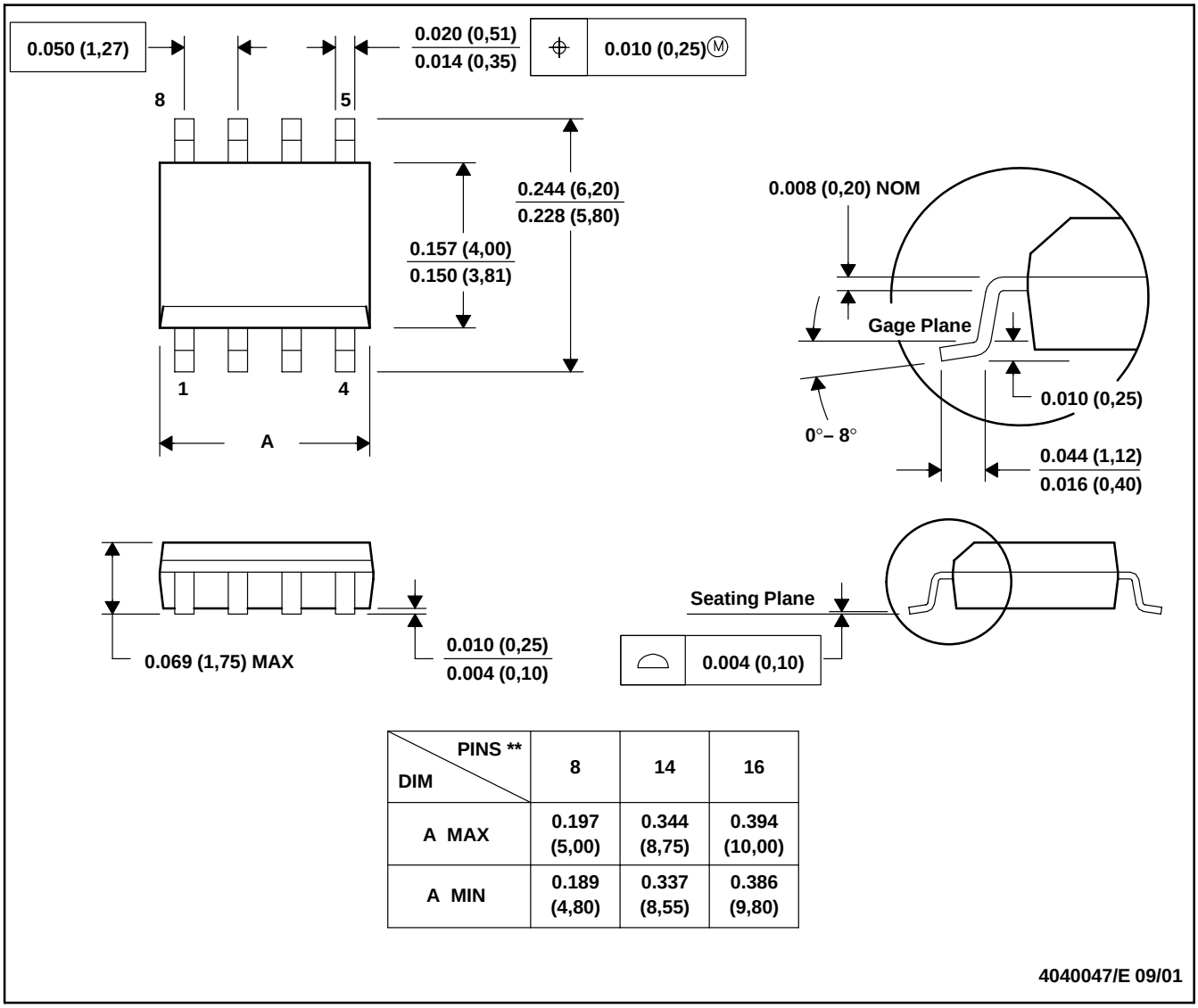
DGK (R-PDSO-G8) **PLASTIC SMALL-OUTLINE PACKAGE**



NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion.
D. Falls within JEDEC MO-187

D (R-PDSO-G)** **PLASTIC SMALL-OUTLINE PACKAGE**

8 PINS SHOWN



DIM \ PINS **	8	14	16
A MAX	0.197 (5,00)	0.344 (8,75)	0.394 (10,00)
A MIN	0.189 (4,80)	0.337 (8,55)	0.386 (9,80)

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NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
D. Falls within JEDEC MS-012

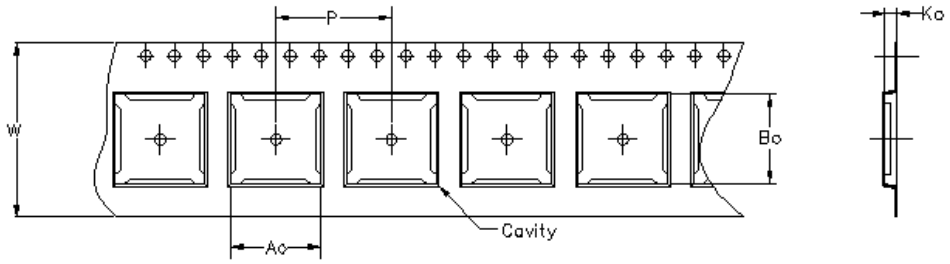
PACKAGING INFORMATION

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
OPA2356AID	ACTIVE	SOIC	D	8	100	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA2356AIDG4	ACTIVE	SOIC	D	8	100	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA2356AIDGKR	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA2356AIDGKRG4	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA2356AIDGKT	ACTIVE	MSOP	DGK	8	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA2356AIDGKTG4	ACTIVE	MSOP	DGK	8	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA2356AIDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA2356AIDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA356AID	ACTIVE	SOIC	D	8	100	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA356AIDBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA356AIDBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA356AIDBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA356AIDBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA356AIDG4	ACTIVE	SOIC	D	8	100	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA356AIDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA356AIDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR

[1] The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

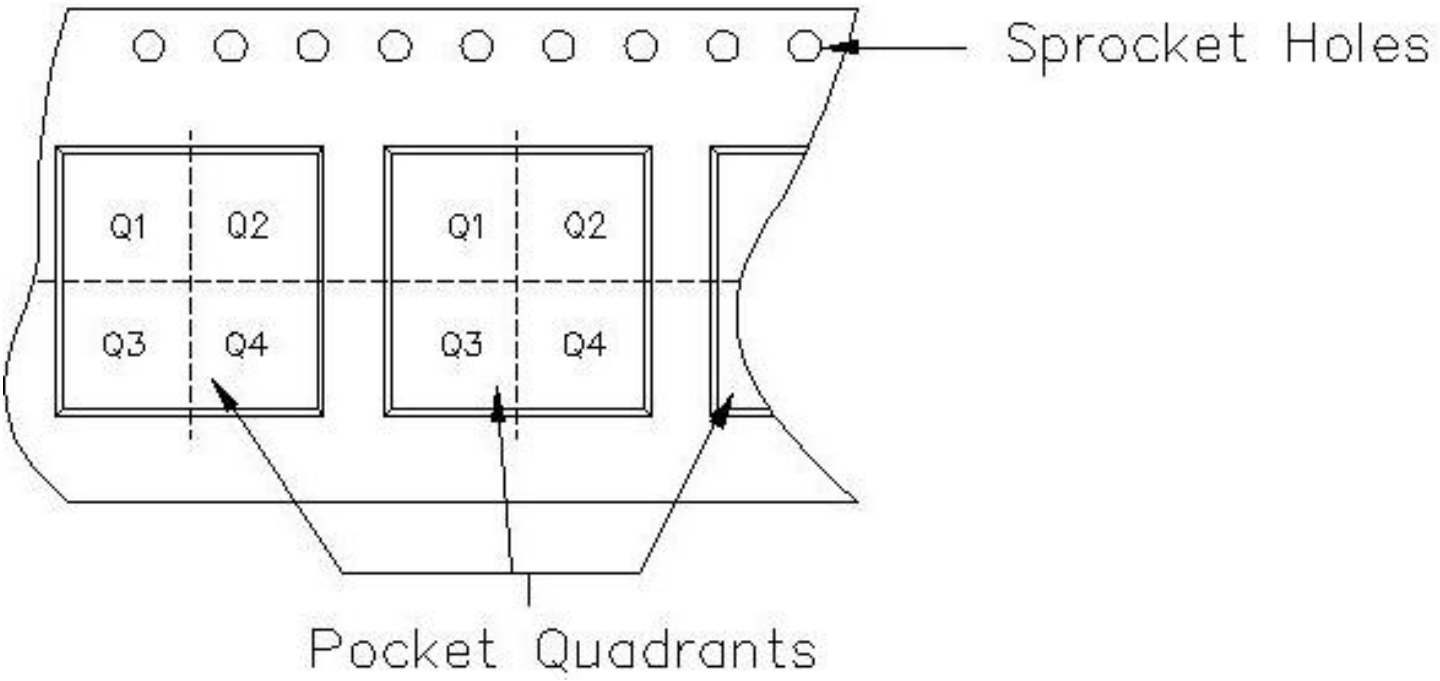
[2] Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



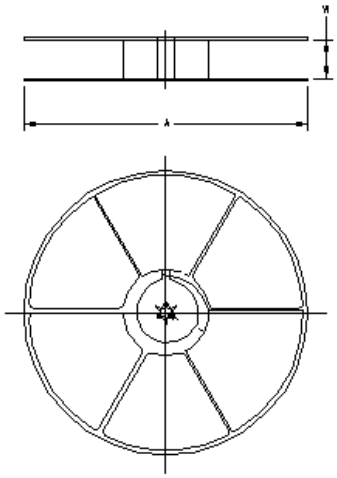
Carrier tape design is defined largely by the component lentgh, width, and thickness.

Ao = Dimension designed to accommodate the component width.
Bo = Dimension designed to accommodate the component length.
Ko = Dimension designed to accommodate the component thickness.
W = Overall width of the carrier tape.
P = Pitch between successive cavity centers.



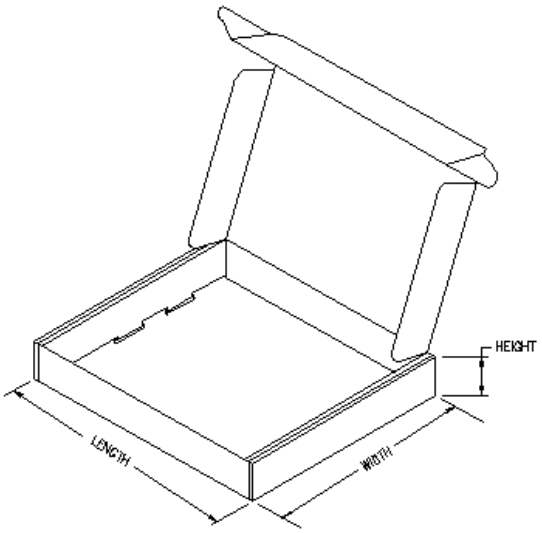
TAPE AND REEL INFORMATION

Device	Package	Pins	Site	Reel Diameter (mm)	Reel Width (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
OPA2356AIDGKR	DGK	8	CAR	0	0	5.3	3.4	1.4	8	12	Q1
OPA2356AIDR	D	8	CRS	0	0	6.4	5.2	2.1	8	12	Q1
OPA356AIDR	D	8	CRS	0	0	6.4	5.2	2.1	8	12	Q1



TAPE AND REEL BOX INFORMATION

Device	Package	Pins	Site	Length (mm)	Width (mm)	Height (mm)
OPA2356AIDGKR	DGK	8	CAR	346.0	346.0	29.0
OPA2356AIDR	D	8	CRS	342.9	336.6	20.6
OPA356AIDR	D	8	CRS	342.9	336.6	20.6


HEIGHT
LENGTH
WIDTH

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